## FEATURES

High Off Isolation -80 dB at $\mathbf{3 0} \mathbf{~ M H z}$
-3 dB Signal Bandwidth 250 MHz
+1.8 V to +5.5 V Single Supply
Low On-Resistance (15 $\Omega$ Typically)
Low On-Resistance Flatness
Fast Switching Times
$t_{\text {on }}$ Typically $8 \mathbf{n s}$
$t_{\text {off }}$ Typically 3 ns
Typical Power Consumption < $0.01 \mu \mathrm{~W}$
TTL/CMOS Compatible

## APPLICATIONS

Audio and Video Switching
RF Switching
Networking Applications
Battery Powered Systems
Communication Systems
Relay Replacement
Sample-and-Hold Systems

## GENERAL DESCRIPTION

The ADG752 is a low voltage SPDT (single pole, double throw) switch. It is constructed using switches in a T-switch configuration, which results in excellent Off Isolation while maintaining good frequency response in the ON condition.
High off isolation and wide signal bandwidth make this part suitable for switching RF and video signals. Low power consumption and operating supply range of +1.8 V to +5.5 V make it ideal for battery powered, portable instruments.

The ADG752 is designed on a submicron process that provides low power dissipation yet gives high switching speed and low on resistance. This part is a fully bidirectional switch and can handle signals up to and including the supply rails. Break-before-make switching action ensures the input signals are protected against momentary shorting when switching between channels.
The ADG752 is available in 6-lead SOT-23 and 8-lead $\mu$ SOIC packages.

## REV. A

## FUNCTIONAL BLOCK DIAGRAM



SWITCH SHOWN FOR A LOGIC "1" INPUT

## PRODUCT HIGHLIGHTS

1. High Off Isolation -80 dB at 30 MHz .
2. -3 dB Signal Bandwidth 250 MHz .
3. Low On Resistance ( $15 \Omega$ ).
4. Low Power Consumption, typically $<0.01 \mu \mathrm{~W}$.
5. Break-Before-Make Switching Action.
6. Tiny 6 -lead SOT-23 and 8 -lead $\mu$ SOIC packages.

|  | $B$ Version |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| Parameter | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \\ & \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  |
| ANALOG SWITCH |  |  |  |  |
| Analog Signal Range |  | 0 V to $\mathrm{V}_{\mathrm{DD}}$ | V |  |
| On-Resistance ( $\mathrm{R}_{\mathrm{ON}}$ ) | 15 |  | $\Omega$ typ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{DS}}=10 \mathrm{~mA}$; |
|  | 18 | 20 | $\Omega$ max | Test Circuit 1 |
| On-Resistance Match Between Channels ( $\Delta \mathrm{R}_{\mathrm{ON}}$ ) | 0.1 |  | $\Omega$ typ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{DS}}=10 \mathrm{~mA}$ |
|  | 0.6 | 0.6 | $\Omega$ max |  |
| On-Resistance Flatness ( $\mathrm{R}_{\text {FLAT(ON) }}$ ) | 2 |  | $\Omega$ typ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ to $2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=10 \mathrm{~mA}$ |
|  |  | 3 | $\Omega$ max | $\mathrm{V}_{\mathrm{DD}}=+4.5 \mathrm{~V}$ |
| LEAKAGE CURRENTS |  |  |  |  |
| Source OFF Leakage $\mathrm{I}_{\text {S }}$ (OFF) | $\pm 0.01$ |  | nA typ | $\mathrm{V}_{\mathrm{D}}=4.5 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 \mathrm{~V} / 4.5 \mathrm{~V}$; |
|  | $\pm 0.25$ | $\pm 3.0$ | $n A \max$ | Test Circuit 2 |
| Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\text {S }}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.01 \\ & \pm 0.25 \end{aligned}$ |  | nA typ | $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{S}}=1 \mathrm{~V}$, or 4.5 V ; |
|  |  | $\pm 3.0$ | nA max | Test Circuit 3 |
| DIGITAL INPUTS |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 0.8 |  | V min | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| Input Low Voltage, V ${ }_{\text {INL }}$ |  |  | $V$ max |  |
| Input Current | 0.001 |  |  |  |
| $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ |  | $\pm 0.5$ | $\mu \mathrm{A}$ typ |  |
|  |  |  | $\mu \mathrm{A}$ max |  |
| $\mathrm{C}_{\text {IN }}$, Digital Input Capacitance | 2 |  | pF typ |  |
| DYNAMIC CHARACTERISTICS ${ }^{1}$ |  |  |  |  |
| $\mathrm{t}_{\mathrm{ON}}$ | 8 | 13 | ns typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; |
|  |  |  | ns max | $\mathrm{V}_{\mathrm{S}}=3 \mathrm{~V}$, Test Circuit 4 |
| $\mathrm{t}_{\text {OFF }}$ | 3 |  | ns typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; |
|  |  | 5 | ns max | $\mathrm{V}_{\mathrm{S}}=3 \mathrm{~V}$, Test Circuit 4 |
| Break-Before-Make Time Delay | 6 |  | ns typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; |
|  |  | 1 | ns min | $\mathrm{V}_{\mathrm{S}}=3 \mathrm{~V}$, Test Circuit 5 |
| Off Isolation | -80 |  | dB typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=30 \mathrm{MHz}$ <br> Test Circuit 6 |
|  |  |  |  |  |
| Crosstalk | -80 |  | dB typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=30 \mathrm{MHz}$ <br> Test Circuit 7 |
|  |  |  |  |  |
| -3 dB Bandwidth | 250 |  | MHz typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$, Test Circuit 8 |
| $\mathrm{C}_{\mathrm{S}}$ (OFF) | 4 |  | pF typ |  |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 15 |  | pF typ |  |
| POWER REQUIREMENTS $\mathrm{I}_{\mathrm{DD}}$ | $\begin{aligned} & 0.001 \\ & 0.1 \end{aligned}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=+5.5 \mathrm{~V}$ |
|  |  |  | $\mu \mathrm{A}$ typ | Digital Inputs $=0 \mathrm{~V}$ or +5.5 V |
|  |  | 0.5 | $\mu \mathrm{A}$ max |  |

NOTES
${ }^{1}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

|  | $B$ Version |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| Parameter | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \\ & \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  |
| ANALOG SWITCH |  |  |  |  |
| Analog Signal Range | 35 | 0 V to $\mathrm{V}_{\mathrm{DD}}$ | V |  |
| On-Resistance ( $\mathrm{R}_{\mathrm{ON}}$ ) |  |  | $\Omega$ typ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{DS}}=10 \mathrm{~mA}$; |
|  |  | 50 | $\Omega$ max | Test Circuit 1 |
| On-Resistance Match Between | 0.2 | 2.5 | $\Omega$ typ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{DS}}=10 \mathrm{~mA}$ |
| Channels ( $\Delta \mathrm{R}_{\mathrm{ON}}$ ) | 2.5 |  | $\Omega$ max |  |
| LEAKAGE CURRENTS <br> Source OFF Leakage IS (OFF) | $\pm 0.01$ |  |  | $\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}$ |
|  |  |  | nA typ | $\mathrm{V}_{\mathrm{S}}=3 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=1 \mathrm{~V} / 3 \mathrm{~V}$ |
|  | $\pm 0.25$ | $\pm 3.0$ | $n A$ max | Test Circuit 2 |
| Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\text {S }}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.01 \\ & \pm 0.25 \end{aligned}$ | $\pm 3.0$ | nA typ nA max | $\begin{aligned} & V_{S}=V_{D}=1 \mathrm{~V} \text { or } 3 \mathrm{~V} \text {; } \\ & \text { Test Circuit } 3 \end{aligned}$ |
|  |  |  |  |  |
| DIGITAL INPUTS |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.0 |  | $V$ min | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.4 |  | V max |  |
| Input Current |  |  |  |  |  |
| $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | 0.001 | $\pm 0.5$ | $\mu \mathrm{A}$ typ $\mu \mathrm{A} \max$ pF typ |  |
|  |  |  |  |  |
| $\mathrm{C}_{\text {IN }}$, Digital Input Capacitance | 2 |  |  |  |
| DYNAMIC CHARACTERISTICS ${ }^{1}$ $\mathrm{t}_{\mathrm{ON}}$ | 10 | 18 |  |  |
|  |  |  |  |  |
|  |  |  | ns max | $\mathrm{V}_{\mathrm{S}}=2 \mathrm{~V}$, Test Circuit 4 |
| $\mathrm{t}_{\text {OFF }}$ | 4 | 8 | ns typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ;$ |
|  |  |  | ns max | $\mathrm{V}_{\mathrm{S}}=2 \mathrm{~V}$, Test Circuit 4 |
| Break-Before-Make Time Delay | 6 | 1 | ns typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ;$ |
|  |  |  | ns min | $\mathrm{V}_{\mathrm{S}}=2 \mathrm{~V}$, Test Circuit 5 |
| Off Isolation | -80 |  | dB typ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=30 \mathrm{MHz} \text {; } \\ & \text { Test Circuit } 6 \end{aligned}$ |
|  |  |  |  |  |
| Crosstalk | -80 |  | dB typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=30 \mathrm{MHz} ;$ <br> Test Circuit 7 |
|  |  |  |  |  |
| -3 dB Bandwidth | 250 |  | MHz typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$, Test Circuit 8 |
| $\mathrm{C}_{\mathrm{S}}$ (OFF) | 4 |  | pF typ |  |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 15 |  | pF typ |  |
| POWER REQUIREMENTS |  |  |  | $\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}$ |
| $\mathrm{I}_{\mathrm{DD}}$ | 0.001 |  | $\mu \mathrm{A}$ typ | Digital Inputs $=0 \mathrm{~V}$ or +3.3 V |
|  | 0.1 | 0.5 | $\mu \mathrm{A}$ max |  |

## NOTES

${ }^{1}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG752 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

# Typical Performance Characteristics-ADG752 



Figure 1. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ Single Supplies


Figure 2. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures $V_{D D}=3 \mathrm{~V}$


Figure 3. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures $V_{D D}=5 \mathrm{~V}$


Figure 4. Supply Current vs. Input Switching Frequency


Figure 5. Off Isolation vs. Frequency


Figure 6. Crosstalk vs. Frequency


Figure 7. On Response vs. Frequency

## GENERAL DESCRIPTION

The ADG752 is an SPDT switch constructed using switches in a T configuration to obtain high "OFF" isolation while maintaining good frequency response in the "ON" condition.

Figure 8 shows the T-switch configuration. While the switch is in the OFF state, the shunt switch is closed and the two series switches are open. The closed shunt switch provides a signal path to ground for any of the unwanted signals that find their way through the off capacitances of the series' MOS devices. This results in more improved isolation between the input and output than with an ordinary series switch. When the switch is in the ON condition, the shunt switch is open and the signal path is through the two series switches which are now closed.


Figure 8. Basic T-Switch Configuration

## LAYOUT CONSIDERATIONS

Where accurate high frequency operation is important, careful consideration should be given to the printed circuit board layout and to grounding. Wire wrap boards, prototype boards and sockets are not recommended because of their high parasitic inductance and capacitance. The part should be soldered directly to a printed circuit board. A ground plane should cover all unused areas of the component side of the board to provide a low impedance path to ground. Removing the ground planes from the area around the part reduces stray capacitance.
Good decoupling is important in achieving optimum performance. $\mathrm{V}_{\mathrm{DD}}$ should be decoupled with a $0.1 \mu \mathrm{~F}$ surface mount capacitor to ground mounted as close as possible to the device itself.


Figure 9. Multiplexing Between Two Video Signals

## Test Circuits



Test Circuit 1. On Resistance


Test Circuit 2. Off Leakage


Test Circuit 3. On Leakage


Test Circuit 4. Switching Times



Test Circuit 6. Off Isolation


Test Circuit 7. Channel-to-Channel Crosstalk


Test Circuit 8. Bandwidth

## ADG752

## OUTLINE DIMENSIONS



Figure 11. 6-Lead Small Outline Transistor Package [SOT-23] (RJ-6)
Dimensions shown in millimeters

## ADG752

ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Brand | Package Description | Package Option |
| :--- | :--- | :--- | :--- | :--- |
| ADG752BRM-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SEB | 8-Lead Mini Small Outline Package [MSOP] | RM-8 |
| ADG752BRMZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | S1H | 8-Lead Mini Small Outline Package [MSOP] | RM-8 |
| ADG752BRT-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SEB | 6-Lead Small Outline Transistor Package [SOT-23] | RJ-6 |
| ADG752BRT-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SEB | 6-Lead Small Outline Transistor Package [SOT-23] | RJ-6 |
| ADG752BRTZ-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SEB\# | 6-Lead Small Outline Transistor Package [SOT-23] | RJ-6 |
| ADG752BRTZ-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SEB\# | 6-Lead Small Outline Transistor Package [SOT-23] | RJ-6 |

${ }^{1} Z=$ RoHS Compliant Part.

## REVISION HISTORY

10/13-Rev. 0 to Rev. A
Updated Outline Dimensions ...................................................... 8
Changes to Ordering Guide .. 9

4/99—Revision 0: Initial Version

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